### Honeywell The power of connected

### **TruStability™ Board Mount Pressure Sensors**

RSC Series—High Resolution, High Accuracy, Compensated  $\pm 1.6$  mbar to  $\pm 10$  bar |  $\pm 160$  Pa to  $\pm 1$  MPa |  $\pm 0.5$  inH<sub>2</sub>O to  $\pm 150$  psi 24-bit Digital SPI-Compatible Output

32321348

Issue C

Datasheet

### DESCRIPTION

The RSC Series is a piezoresistive silicon pressure sensor offering a digital output for reading pressure over the specified full scale pressure span and temperature range. It is calibrated and temperature compensated for sensor offset, sensitivity, temperature effects, and non-linearity using a 24-bit analog-to-digital converter with integrated EEPROM. Pressure data may be acquired at rates between 20 and 2000 samples per second over an SPI interface. It is intended for use with non-corrosive, non-ionic gases, such as air and other dry gases, designed and manufactured according to ISO 9001 standards, and is REACH and RoHS compliant.

### VALUE TO CUSTOMERS

- Enhances performance: Output accelerates performance through reduced conversion requirements and direct interface to microprocessors. Proprietary Honeywell technology combines high sensitivity with high burst and over pressure while providing industry leading stability (performance factors difficult to achieve in the same sensor), providing flexibility in implementation and minimizing requirements for protecting the sensor without sacrificing ability to sense very small changes in pressure.
- Cost-effective, high volume solution with a variety of options.
- Enhances reliability: High burst pressures promote system reliability, minimize downtime, and can simplify design. High working pressures allow ultra-low sensors to be used continuously above the calibrated pressure range.
- Easy to design in: Package is small when compared to many similar sensors, occupying less area on the PCB. Port and housing options simplify integration. Wide pressure range simplifies use.
- Meets IPC/JEDEC J-STD-020D.1 Moisture Sensitivity Level 1 requirements: Allows avoidance of thermal and mechanical damage during solder reflow attachment and/or repair that lesser rated sensors would incur, allows unlimited floor life when stored as specified (simplifying storage and reducing scrap), eliminates lengthy bakes prior to reflow, and allows for lean manufacturing due to stability and usability shortly after reflow.
- Energy efficient: Reduces system power requirements and enables extended battery life.

#### FEATURES

- Pressure range: ±1.6 mbar to ±10 bar | ±160 Pa to ±1 MPa | ±0.5 inH<sub>2</sub>O to ±150 psi; absolute range 1 bar to 8 bar | 15 psi to 150 psi
- Pressure types: Absolute: internal vacuum reference and an output value proportional to absolute pressure; Gage: referenced to atmospheric pressure and provide an output proportional to pressure variations from atmosphere; Differential: allows measurement of pressure between the two pressure ports
- Total Error Band: As low as ±0.25 %FSS depending on pressure range (after auto zero)
- Accuracy: ±0.1 %FSS BFSL (Full Scale Span Best Fit Straight Line)
- Compensated temperature range: -40°C to 85°C [-40°F to 185°F]
- Power consumption: Less than 10 mW, typ.
- Size: Miniature 10 mm x 12,5 mm [0.39 in x 0.49 in] package
- Output: 24-bit digital SPI-compatible
- Meets IPC/JEDEC J-STD-020D.1 Moisture Sensitivity Level 1 requirements

#### DIFFERENTIATION

- Industry-leading long-term stability: Minimizes system calibration needs and significantly reduces downtime.
- Industry-leading accuracy: Reduces software to correct system inaccuracies, which minimizes design time, helps improve efficiency, and often simplifies development.
- Industry-leading flexibility: Modular design with many package styles and options simplify integration.
- Total Error Band: Provides true performance over the compensated temperature range, which eliminates the need to test and calibrate every sensor, thereby reducing manufacturing cost. Improves system accuracy and offers ease of sensor interchangeability due to minimal part-to-part variation (see Figure 1 on page 3).

#### **POTENTIAL APPLICATIONS**

- Medical: Airflow monitors, anesthesia machines, blood analysis machines, gas chromatography, gas flow instrumentation, hospital room air pressure, kidney dialysis machines, nebulizers, pneumatic controls, respiratory machines, sleep apnea equipment, spirometers, ventilators
- Industrial: Barometry, drones, flow calibrators, gas chromatography, gas flow instrumentation, HVAC clogged filter detection, HVAC systems, HVAC transmitters, indoor air quality, life sciences, pneumatic control, VAV (Variable Air Volume) control, weather balloons

#### PORTFOLIO

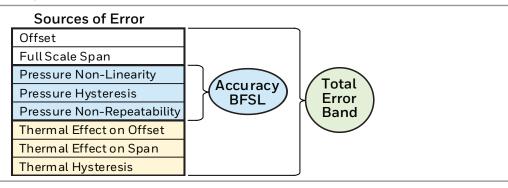
Honeywell offers a variety of board mount pressure sensors for potential use in medical and industrial applications. Our categories of pressure sensor measurement include absolute, differential, gage or vacuum gage, with unamplified or amplified sensors and covering a wide pressure range.

# TruStability<sup>™</sup> Board Mount Pressure Sensors RSC Series

### **Table of Contents**

Gene	ral Specifications
Nome	enclature and Order Guide
Press	ure Range Specifications
±1.6	mbar to ±10 bar
±16	0 Pa to ±1 MPa
±0.5	inH <sub>2</sub> 0 to ±150 psi
Dime	nsional Drawings
DIP	Packages
SMI	<sup>¬</sup> Packages
Reco	mmended PCB Pad Layouts
Pinou	<b>ιt</b>
Reco	mmended Circuit
1.0	System Overview
	1.1 Major System Blocks
	1.2 High-level Operating Sequence
	1.3 Compensation Mathematics
2.0	System Initialization – EEPROM
	2.1 EEPROM Contents
	2.2 EEPROM Communication
3.0	System Operation – ADC
	3.1 ADC Communications and Initialization
	3.2 Programming the Data Rate and Pressure/Temperature Modes
	3.3 ADC Reset Command
	3.4 ADC Programming Sequence – Power Up
	3.5 ADC Programming and Read Sequence – Temperature Reading
	3.6 ADC Programming and Read Sequence – Pressure Reading
4.0	Example Software
	4.1 Data Types
	4.2 Function Descriptions – Pressure_Comp.c
	4.3 Checksum Calculation
	4.4 Compensation Sequence
	4.5 Constraints
5.0	Sensor Offset Zero Correction Procedure
Addit	ional Information back page

#### Figure 1. TEB Components for TruStability™ Board Mount Pressure Sensors



#### Table 1. Absolute Maximum Ratings<sup>1</sup>

Characteristic	Min.	Max.	Unit	
Supply voltage (V <sub>supply</sub> )	2.7	6.0	Vdc	
Voltage on any pin	-0.3	V <sub>supply</sub> + 0.3	V	
Digital interface clock frequency	_	5	MHz	
ESD susceptibility (human body model)	-	2	kV	
Storage temperature	-40 [-40]	85 [185]	°C [°F]	
Soldering time and temperature: lead solder temperature (DIP) peak reflow temperature (SMT)		4 s max. at 250°C [482°F] 15 s max. at 250°C [482°F]		

<sup>1</sup>Absolute maximum ratings are the extreme limits the device will withstand without damage.

#### **Table 2. Environmental Specifications**

Characteristic	Parameter
Humidity (gases only)	0% to 95% RH, non-condensing
Vibration	15 g, 10 Hz to 2 Hz
Shock	100 g, 6 ms duration
Life <sup>1</sup>	1 million pressure cycles minimum
Solder reflow	J-STD-020-D.1 Moisture Sensitivity Level 1 (unlimited shelf life when stored at $\leq$ 30°C/85 % RH)

<sup>1</sup>Life may vary depending on specific application in which the sensor is utilized.

#### Table 3. Wetted Materials<sup>1</sup>

Component	Port 1 (Pressure Port)	Port 2 (Reference Port)		
Ports and covers	high temperature polyamide	high temperature polyamide		
Substrate	alumina ceramic	alumina ceramic		
Adhesives	epoxy, silicone	epoxy, silicone		
Electronic components	plastic, silicon, glass, solder	silicon, glass, gold		

<sup>1</sup>Contact Honeywell Customer Service for detailed material information.

#### **Table 4. Sensor Pressure Types**

Pressure Type	Description
Absolute	Output is proportional to the difference between applied pressure and a built-in vacuum reference.
Differential	Output is proportional to the difference between the pressures applied to each port (Port 1 – Port 2).
Gage	Output is proportional to the difference between applied pressure and atmospheric (ambient) pressure.

## TruStability<sup>™</sup> Board Mount Pressure Sensors

**RSC** Series

#### **Table 5. Digital Operating Specifications**

Characteristic	Min.	Тур.	Max.	Unit
Supply voltage (V <sub>supply</sub> ): <sup>1,2,3</sup> pressure ranges ≥60 mbar   6 kPa   1 psi: 3.3 Vdc 5.0 Vdc pressure ranges ≤40 mbar   4 kPa   20 inH <sub>2</sub> 0:	3.0 4.75	3.3 5.0	3.6 5.25	Vdc
3.3 Vdc 5.0 Vdc	3.27 4.95	3.3 5.0	3.33 5.05	
Supply current: 3.3 Vdc: standby mode active mode 5.0 Vdc: standby mode active mode	_ _ _ _	1.3 1.7 2.1 2.6	_ _ _ _	mA
Operating temperature range <sup>4</sup>	-40 [-40]	_	85 [185]	°C [°F]
Compensated temperature range: <sup>5</sup> medical industrial extended	0 [32] -20 [-4] -40 [-40]		50 [122] 85 [185] 85 [185]	°C [°F]
Startup time (power up to data ready)	_	_	0.3	ms
Data rate	20, 40, 45, 90, 175, 180, 330, 350, 600, 660, 1000, 1200, 2000			samples per second
SPI voltage level: low high			20	%Vsupply
Pull up on MISO, SCLK, CS_ADC, CS_EE, MOSI	1	—	—	kOhm
Accuracy <sup>6</sup>	_	_	0.1	%FSS BFSL <sup>6</sup>
Orientation sensitivity (±1 g): <sup>7.9</sup> pressure ranges $\leq$ 40 mbar   4 kPa   20 inH <sub>2</sub> 0 pressure ranges $\leq$ 2.5 mbar   250 Pa   1 inH <sub>2</sub> 0		±0.1 ±0.2	_	%FSS <sup>8</sup>

 $^1\!Sensors$  are either 3.3 Vdc or 5.0 Vdc based on the catalog listing selected.

<sup>2</sup>Ratiometricity of the sensor (the ability of the device output to scale to the supply voltage) is achieved within the specified operating voltage.

<sup>3</sup>The sensor is not reverse polarity protected. Incorrect application of supply voltage or ground to the wrong pin may cause electrical failure.

<sup>4</sup>Operating temperature range: The temperature range over which the sensor will produce an output proportional to pressure.

<sup>5</sup>Compensated temperature range: The temperature range over which the sensor will produce an output proportional to pressure within the specified performance limits (Total Error Band).

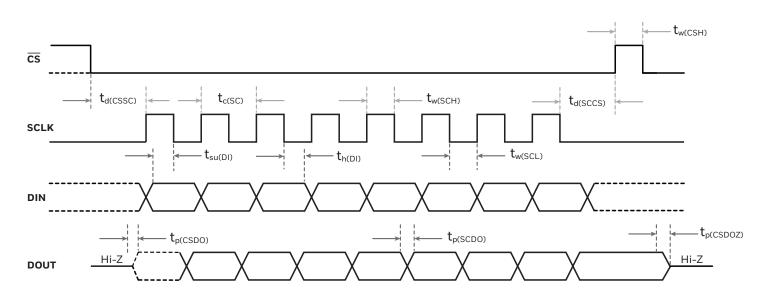
<sup>6</sup>Accuracy: The maximum deviation in output from a Best Fit Straight Line (BFSL) fitted to the output measured over the pressure range. Includes all errors due to pressure non-linearity, pressure hysteresis, and non-repeatability.

<sup>7</sup>Orientation sensitivity: The maximum change in offset of the sensor due to a change in position or orientation relative to Earth's gravitational field. <sup>8</sup>Full Scale Span (FSS): The algebraic difference between the output signal measured at the maximum (Pmax.) and minimum (Pmin.) limits of the pressure range. (See Figure 1 for ranges.)

<sup>9</sup>Insignificant for pressure ranges above 40 mbar | 4 kPa | 20 inH<sub>2</sub>0.

# TruStability<sup>™</sup> Board Mount Pressure Sensors RSC Series

#### Figure 2. SPI Timing Requirements<sup>1</sup>



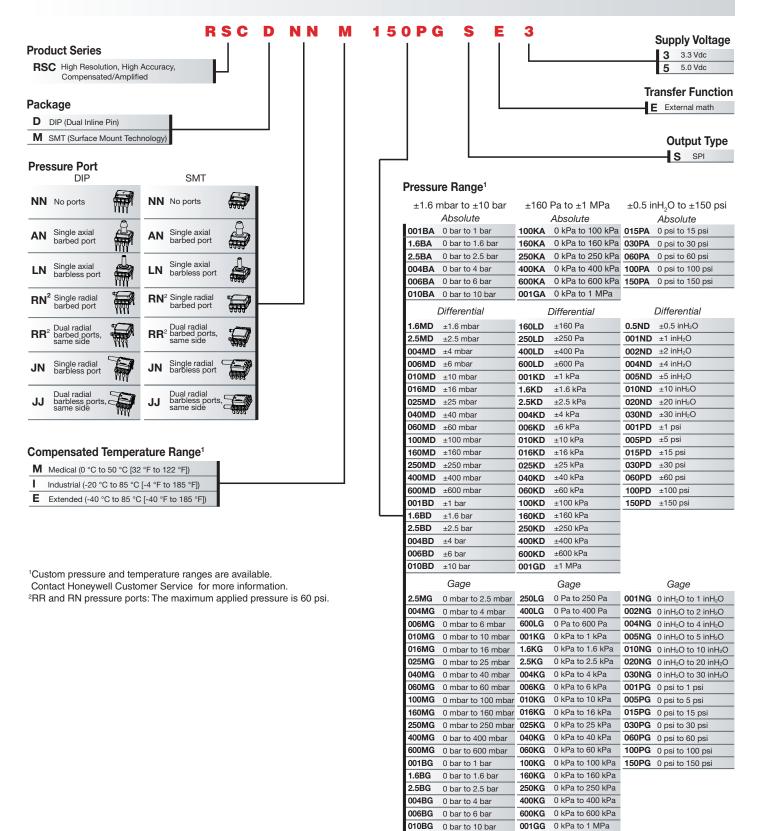
Characteristic	Description	Min.	Max.	Unit
t <sub>d(CSSC)</sub>	delay time; $\overline{\text{CS}}$ falling edge to first SCLK rising edge	50	_	ns
t <sub>d(SCCS)</sub>	delay time,;final SCLK falling edge to $\overline{\text{CS}}$ rising edge	30	_	ns
t <sub>w(CSH)</sub>	pulse duration; $\overline{CS}$ high	80	_	ns
t <sub>c(SC)</sub>	SCLK period	150	_	ns
t <sub>w(SCH)</sub>	pulse duration; SCLK high	75	_	ns
t <sub>w(SCL)</sub>	pulse duration; SCLK low	75	_	ns
t <sub>su(DI)</sub>	setup time; DIN valid before SCLK falling edge	50	_	ns
t <sub>h(DI)</sub>	hold time; DIN valid after SCLK falling edge	25	_	ns
t <sub>p(CSDO)</sub>	propagation delay time; $\overline{\text{CS}}$ falling edge to DOUT driven		50	ns
t <sub>p(SCDO)</sub>	propagation delay time; SCLK rising edge to valid new DOUT	0	50	ns
t <sub>p(CSDOZ)</sub>	propagation delay time; $\overline{\text{CS}}$ rising edge to DOUT high impedance	_	50	ns

<sup>1</sup>Single byte communication is shown. Actual communication may be several bytes.

**RSC** Series

#### Figure 3. Nomenclature and Order Guide

For example, **RSCDNNM150PGSE3** defines an RSC Series TruStability<sup>™</sup> Pressure Sensor, DIP package, NN pressure port, medical compensated temperature range, 150 psi gage pressure range, SPI output type, external math transfer function, 3.3 Vdc supply voltage.





**RSC** Series

Pressure Range	Pressure Range			Working	orking Over	Burst	Common	Total Error	Total Error Band after	Long-term Stability	Effective Number of	
(see Figure 3)	Pmin.	Pmax.	Unit	Unit	Pressure <sup>1</sup>	Pressure <sup>2</sup>	Pressure <sup>3</sup>	Mode Pressure <sup>4</sup>	Band⁵ (%FSS)	Auto-Zero <sup>6</sup> (%FSS)	1000 hr, 25°C (%FSS)	
						Absol	ute	-				
001BA	0	1	bar	_	2	4	_	±0.75	±0.25	±0.25	16	
1.6BA	0	1.6	bar	_	4	8	_	±0.75	±0.25	±0.25	16	
2.5BA	0	2.5	bar	_	6	8	_	±0.75	±0.25	±0.25	16	
004BA	0	4	bar	_	8	16	_	±0.75	±0.25	±0.25	16	
006BA	0	6	bar	_	17	17	_	±0.75	±0.25	±0.25	15	
010BA	0	10	bar	_	17	17	_	±0.75	±0.25	±0.25	16	
						Differe	ntial					
1.6MD	-1.6	1.6	mbar	335	675	1000	3450	±3	±0.5	±0.5	16	
2.5MD	-2.5	2.5	mbar	335	675	1000	3450	±2	±0.5	±0.35	14	
004MD	-4	4	mbar	335	675	1000	3450	±2	±0.5	±0.35	15	
006MD	-6	6	mbar	335	675	1000	3450	±2	±0.5	±0.35	16	
010MD	-10	10	mbar	375	750	1250	5450	±0.75	±0.25	±0.25	16	
016MD	-16	16	mbar	375	750	1250	5450	±1	±0.25	±0.25	17	
025MD	-25	25	mbar	435	850	1350	10450	±1	±0.25	±0.25	18	
040MD	-40	40	mbar	435	850	1350	10450	±0.75	±0.25	±0.25	15	
060MD	-60	60	mbar		850	1000	10000	±0.75	±0.25	±0.25	15	
100MD	-100		mbar	_	1400	2500	10000	±0.75	±0.25	±0.25	15	
160MD	-160		mbar		1400	2500	10000	±0.75	±0.25	±0.25	16	
250MD	-250		mbar		1400	2500	10000	±0.75	±0.25	±0.25	16	
400MD	-400		mbar	_	2000	4000	10000	±0.75	±0.25	±0.25	15	
600MD	-600		mbar	_	2000	4000	10000	±0.75	±0.25	±0.25	16	
001BD	-1	1	bar	_	4	8	10	±0.75	±0.25	±0.25	16	
1.6BD	-1.6	1.6	bar	_	8	16	10	±0.75	±0.25	±0.25	16	
2.5BD	-2.5	2.5	bar	_	8	16	10	±0.75	±0.25	±0.25	16	
004BD	-4.0	4.0	bar	_	16	17	10	±0.75	±0.25	±0.25	16	
006BD	-6	6	bar	_	17	17	17	±0.75	±0.25	±0.25	16	
010BD	-10	10	bar	_	17	17	17	±0.75	±0.25	±0.25	17	
01000	1 10	10	bui		1	Gag		20.10	20.20	10.20	±1	
2.5MG	0	2.5	mbar	335	675	1000	3450	±3	±0.5	±0.5	15	
004MG	0	4	mbar	335	675	1000	3450	±3	±0.5	±0.5	16	
006MG	0	6	mbar	335	675	1000	3450	±2	±0.5	±0.35	15	
010MG	0	10	mbar	335	675	1000	3450	±0.75	±0.25	±0.35	15	
016MG	0	16	mbar	335	675	1000	3450	±0.75	±0.25	±0.25	16	
025MG	0	25	mbar	375	750	1250	5450	±1	±0.25	±0.25	17	
040MG	0	40	mbar	375	750	1250	5450	±0.75	±0.25	±0.25	15	
040MG	0	60	mbar		850	1230	5450	±0.75	±0.25	±0.25	14	
100MG	0	100	mbar		850	1000	10000	±0.75	±0.25	±0.25	14	
	-							1				
160MG 250MG	0	160 250	mbar		850 1400	1000 2500	10000	±0.75 ±0.75	±0.25 ±0.25	±0.25 ±0.25	16 15	
400MG	0	400	mbar mbar		2000	4000	10000	±0.75 ±0.75	±0.25 ±0.25	±0.25 ±0.25	15	
400MG	0	600	mbar	_	2000	4000	10000	±0.75 ±0.75	±0.25 ±0.25	±0.25 ±0.25	14	
001BG	0	1				4000	10000	±0.75 ±0.75	±0.25 ±0.25	±0.25 ±0.25	16	
1.6BG	0	1.6	bar	_	2 4	8	10	±0.75 ±0.75	±0.25 ±0.25	±0.25 ±0.25		
			bar								16	
2.5BG	0	2.5	bar		8	16	10	±0.75	±0.25	±0.25	15	
004BG	0	4	bar		8	16 17	16 17	±0.75	±0.25	±0.25	16	
006BG 010BG	0	6 10	bar		17	17	17	±0.75 ±0.75	±0.25 ±0.25	±0.25 ±0.25	15 16	
	-		bar							utside the opera		

#### Table 6. Pressure Range Specifications for ±1.6 mbar to ±10 bar

<sup>1</sup>Working Pressure: The maximum pressure that may be applied to any port of the sensor in continuous use. This pressure may be outside the operating pressure range limits (Pmin. to Pmax.) in which case the sensor may not provide a valid output until pressure is returned to within the operating pressure range. Tested to 1 million cycles, minimum.

<sup>2</sup>Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified this applies to all available pressure ports at any temperature with the operating temperature range.

Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. Product should not be expected to function after exposure to any pressure beyond the burst pressure.

<sup>4</sup>Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

<sup>5</sup>Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range. Includes all errors due to offset, full scale span, pressure non-linearity, pressure hysteresis, repeatability, thermal effect on offset, thermal effect on span, and thermal hysteresis (see Figure 1).
<sup>6</sup>Total Error Band after Auto-Zero: The maximum deviation from the ideal transfer function over the entire compensated pressure range for a minimum of 24 hours after an auto-zero operation. Includes all errors due to full scale span, pressure non-linearity, pressure hysteresis, and thermal effect on span.

<sup>2</sup>Effective Number of Bits (ENOB): A measure of the dynamic performance of an analog-to-digital converter (ADC) and its related circuitry. ENOB is defined for the RSC Series per the following equation: ENOB = log<sub>2</sub> (Full Scale Span/Noise).

**RSC** Series

#### Pressure Pressure **Total Error** Long-term Effective Range **Total Error** Common Stability 1000 hr, 25°C Range Working Over Burst **Band after** Number of Unit Mode Band<sup>5</sup> Pmin. Pmax (see Pressure Pressure<sup>2</sup> **Pressure**<sup>3</sup> Auto-Zero<sup>6</sup> **Bits (ENOB)** Pressure<sup>4</sup> (%FSS) Figure 3) (%FSS) (%FSS) at 20 SPS<sup>7</sup> Absolute 100KA 0 100 kPa 200 400 ±0.75 ±0.25 ±0.25 16 160KA 0 160 kPa 400 800 16 ±0.75 ±0.25 ±0.25 0 250 250KA kPa 600 800 ±0.75 ±0.25 ±0.25 16 400KA 0 400 800 1600 ±0.25 16 kPa ±0.75 ±0.25 600KA 0 600 kPa 1700 1700 ±0.75 ±0.25 ±0.25 15 ±0.25 16 001GA 0 1 MPa 1700 1700 ±0.75 ±0.25 Differential 160LD -160 160 Ра 33500 67500 100000 345000 ±З ±0.5 ±0.5 16 250LD -250 250 Pa 33500 67500 100000 345000 ±2 ±0.5 ±0.35 14 400 400 33500 67500 100000 345000 ±2 ±0.5 ±0.35 15 400LD Pa 67500 600 33500 100000 345000 ±2 ±0.5 ±0.35 16 600LD 600 Pa 001KD kPa 37.5 75 ±0.75 ±0.25 -1 1 125 545 +0.2516 -1.6 1.6 kPa 37.5 75 125 545 ±1 ±0.25 ±0.25 17 1.6KD 43.5 2.5KD -2.5 2.5 kPa 85 135 1045 +1 ±0.25 ±0.25 18 43.5 135 1045 ±0.75 ±0.25 ±0.25 15 004KD -4 4 kPa 85 006KD -6 6 kPa 85 100 1000 ±0.75 ±0.25 ±0.25 15 -10 010KD 10 kPa 140 250 1000 ±0.75 ±0.25 ±0.25 16 \_ kPa 016KD -16 16 140 250 1000 ±0.75 ±0.25 +0.2517 \_ 025KD -25 25 kPa 140 250 1000 ±0.75 ±0.25 ±0.25 16 040KD -40 40 kPa 200 400 1000 ±0.75 ±0.25 ±0.25 17 060KD -60 60 200 400 1000 ±0.75 ±0.25 ±0.25 16 kPa ±0.75 ±0.25 ±0.25 100KD -100 100 kPa 400 800 1000 16 160KD -160 160 800 1600 1000 ±0.75 ±0.25 ±0.25 16 kPa 250KD -250 250 800 1600 ±0.75 ±0.25 ±0.25 16 kPa 1000 400KD -400 400 kPa 1600 1700 1000 ±0.75 ±0.25 ±0.25 16 \_ 600 600 1700 1700 1700 ±0.75 ±0.25 ±0.25 600KD kPa 16 MPa 1.7 ±0.25 001GD -1 1 1.7 1.7 ±0.75 ±0.25 17 Gage 250LG 250 ±0.5 15 0 Pa 33500 67500 100000 345000 ±З ±0.5 400LG 0 400 Pa 33500 67500 345000 +0.5+0.5100000 +3 16 67500 345000 ±2 ±0.5 ±0.35 15 600LG 0 600 Pa 33500 100000 001KG 0 1 kPa 33.5 675 100 345 ±0.75 ±0.25 ±0.35 15 345 1.6KG 0 1.6 kPa 33.5 67.5 100 ±0.75 ±0.25 ±0.25 16 2.5KG 0 2.5 kPa 37.5 75 125 545 +1 +0.25+0.2517 37.5 125 545 004KG 0 4 kPa 75 ±0.75 ±0.25 ±0.25 15 100 545 ±0.75 ±0.25 ±0.25 14 006KG 0 6 kPa 85 010KG 0 10 kPa 85 100 1000 ±0.75 ±0.25 ±0.25 15 ±0.75 0 85 100 1000 ±0.25 ±0.25 016KG 16 kPa 16 kPa 0 140 250 1000 ±0.75 ±0.25 ±0.25 15 025KG 25 \_ 040KG 0 40 kPa 200 400 1000 ±0.75 ±0.25 ±0.25 14 060KG 0 60 kPa 200 400 1000 ±0.75 ±0.25 ±0.25 15 100KG 0 100 kPa 200 400 1000 ±0.75 ±0.25 ±0.25 16 400 ±0.25 ±0.25 16 160KG 0 160 kPa 800 1000 ±0.75 250 ±0.75 ±0.25 ±0.25 15 250KG 0 kPa 800 1600 1000 400KG 0 400 kPa 1600 ±0.75 ±0.25 ±0.25 16 800 1600 \_ 600KG 0 600 kPa 1700 1700 1700 ±0.75 ±0.25 ±0.25 15 001GG 0 1 MPa 17 1.7 1.7 ±0.75 ±0.25 +0.2516

Table 7. Pressure Range Specifications for ±160 Pa to ±1 MPa

<sup>1</sup>Working Pressure: The maximum pressure that may be applied to any port of the sensor in continuous use. This pressure may be outside the operating pressure range limits (Pmin. to Pmax.) in which case the sensor may not provide a valid output until pressure is returned to within the operating pressure range. Tested to 1 million cycles, minimum.

<sup>2</sup>Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified this applies to all available pressure ports at any temperature with the operating temperature range.

<sup>3</sup>Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. Product should not be expected to function after exposure to any pressure beyond the burst pressure.

<sup>4</sup>Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

<sup>5</sup>Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range. Includes all errors due to offset, full scale span, pressure non-linearity, pressure hysteresis, repeatability, thermal effect on offset, thermal effect on span, and thermal hysteresis (see Figure 1).
<sup>6</sup>Total Error Band after Auto-Zero: The maximum deviation from the ideal transfer function over the entire compensated pressure range for a minimum of 24 hours after an auto-zero operation. Includes all errors due to full scale span, pressure non-linearity, pressure hysteresis, and thermal effect on span.

<sup>2</sup>Effective Number of Bits (ENOB): A measure of the dynamic performance of an analog-to-digital converter (ADC) and its related circuitry. ENOB is defined for the RSC Series per the following equation: ENOB = log<sub>2</sub> (Full Scale Span/Noise).

**RSC** Series

#### Pressure Pressure **Total Error** Long-term Effective Common **Total Error** Range Range Working Over Burst **Band after** Stability Number of Unit Mode Band⁵ Pmax. Pressure<sup>2</sup> Pressure<sup>3</sup> Auto-Zero<sup>6</sup> 1000 hr, 25°C **Bits (ENOB)** Pmin **Pressure**<sup>1</sup> (see Pressure<sup>4</sup> (%FSS) Figure 3) (%FSS) (%FSS) at 20 SPS<sup>7</sup> Absolute 015PA 30 60 ±0.75 ±0.25 ±0.25 16 15 psi 030PA 0 30 60 120 ±0.75 ±0.25 ±0.25 16 psi 120 060PA 0 60 psi 240 ±0.75 ±0.25 ±0.25 16 100PA 0 100 250 250 ±0.75 ±0.25 ±0.25 16 psi 150PA 0 150 psi 250 250 ±0.75 ±0.25 ±0.25 16 Differential 415 1400 0.5ND -0.5 0.5 inH<sub>2</sub>O 135 270 +3 +0.5+0.516 001ND -1 1 inH<sub>2</sub>O 135 270 415 1400 ±2 ±0.5 ±0.35 15 002ND -2 2 inH<sub>2</sub>O 135 270 415 1400 ±2 ±0.5 ±0.35 16 150 ±0.25 17 004ND -4 4 300 500 2200 ±0.75 ±0.25 inH<sub>2</sub>O -5 5 inH<sub>2</sub>O 150 300 500 2200 ±0.5 19 005ND ±З ±0.25 010ND -10 10 inH<sub>2</sub>O 175 350 550 4200 ±1 ±0.25 ±0.25 19 550 ±0.25 ±0.25 020ND -20 20 inH<sub>2</sub>O 175 350 4200 ±0.75 16 -30 30 inH<sub>2</sub>O 175 350 550 4200 ±0.75 ±0.25 ±0.25 030ND 16 001PD -1 1 10 15 150 ±0.75 ±0.25 ±0.25 15 psi -5 005PD 5 \_ 30 40 150 ±0.75 ±0.25 ±0.25 17 psi 015PD -15 15 60 120 150 ±0.75 ±0.25 ±0.25 17 psi -30 120 030PD 30 psi 240 150 ±0.75 ±0.25 ±0.25 17 060PD -60 60 250 250 psi 250+0.75+0.25±0.25 17 \_ 100PD -100 100 250 250 250 ±0.75 ±0.25 ±0.25 17 psi 150PD -150 150 psi 250 250 250 ±0.75 ±0.25 ±0.25 17 Gage 135 270 415 ±0.5 16 001NG 1 inH<sub>2</sub>O 1400 ±З ±0.5 002NG 0 2 inH<sub>2</sub>O 135 270 415 1400 ±2 ±0.5 ±0.35 15 ±0.75 ±0.25 004NG 4 inH<sub>2</sub>O 135 270 415 1400 ±0.35 16 0 5 005NG inH<sub>2</sub>O 135 270 415 1400 ±0.75 ±0.25 16 ±0.25 0 150 18 010NG 10 $inH_2O$ 300 500 2200 +0.25±0.25 ±1 020NG 0 20 $inH_2O$ 175 350 550 4200 ±0.75 ±0.25 ±0.25 15 030NG 0 30 inH<sub>2</sub>O 175 350 550 4200 ±0.75 ±0.25 ±0.25 15 0 14 001PG 1 10 15 150 ±0.75 ±0.25 ±0.25 psi 5 150 0 30 40 ±0.75 ±0.25 ±0.25 005PG psi 16 015PG 0 150 15 30 60 ±0.75 ±0.25 ±0.25 16 psi 030PG 0 30 60 120 150 ±0.75 ±0.25 ±0.25 16 psi 060PG 0 60 psi 120 240 250 ±0.75 ±0.25 ±0.25 16 100PG 100 250 250 250 ±0.75 ±0.25 ±0.25 0 psi 16 150PG 0 150 250 250 250 ±0.75 ±0.25 ±0.25 psi 16

#### Table 8. Pressure Range Specifications for ±0.5 inH<sub>2</sub>O to ±150 psi

<sup>1</sup>Working Pressure: The maximum pressure that may be applied to any port of the sensor in continuous use. This pressure may be outside the operating pressure range limits (Pmin, to Pmax.) in which case the sensor may not provide a valid output until pressure is returned to within the operating pressure range. Tested to 1 million cycles, minimum.

<sup>2</sup>Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified this applies to all available pressure ports at any temperature with the operating temperature range.

<sup>3</sup>Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. Product should not be expected to function after exposure to any pressure beyond the burst pressure.

<sup>4</sup>Common Mode Pressure: The maximum pressure that can be applied simultaneously to both ports of a differential pressure sensor without causing changes in specified performance.

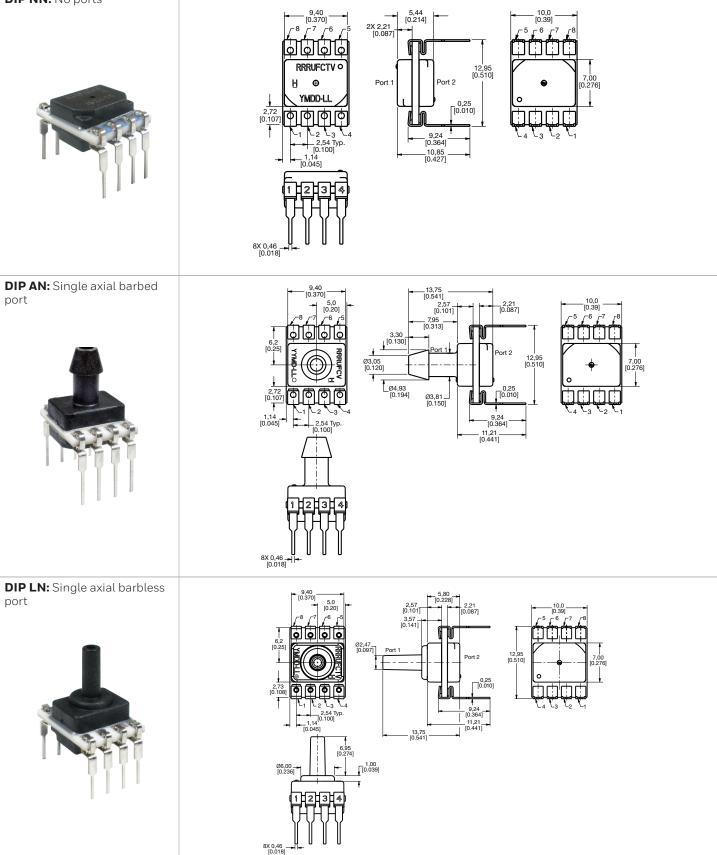
<sup>5</sup>Total Error Band: The maximum deviation from the ideal transfer function over the entire compensated temperature and pressure range. Includes all errors due to offset, full scale span, pressure non-linearity, pressure hysteresis, repeatability, thermal effect on offset, thermal effect on span, and thermal hysteresis (see Figure 1). <sup>6</sup>Total Error Band after Auto-Zero: The maximum deviation from the ideal transfer function over the entire compensated pressure range for a minimum of 24 hours after an auto-zero operation. Includes all errors due to full scale span, pressure non-linearity, pressure hysteresis, and thermal effect on span.

an auto-zero operation. Includes all errors due to full scale span, pressure non-linearity, pressure hysteresis, and thermal effect on span. <sup>7</sup>Effective Number of Bits (ENOB): A measure of the dynamic performance of an analog-to-digital converter (ADC) and its related circuitry. ENOB is defined for the RSC Series per the following equation: ENOB = log<sub>2</sub> (Full Scale Span/Noise).

**RSC** Series

#### Figure 4. DIP Package Dimensional Drawings (For reference only: mm [in].)

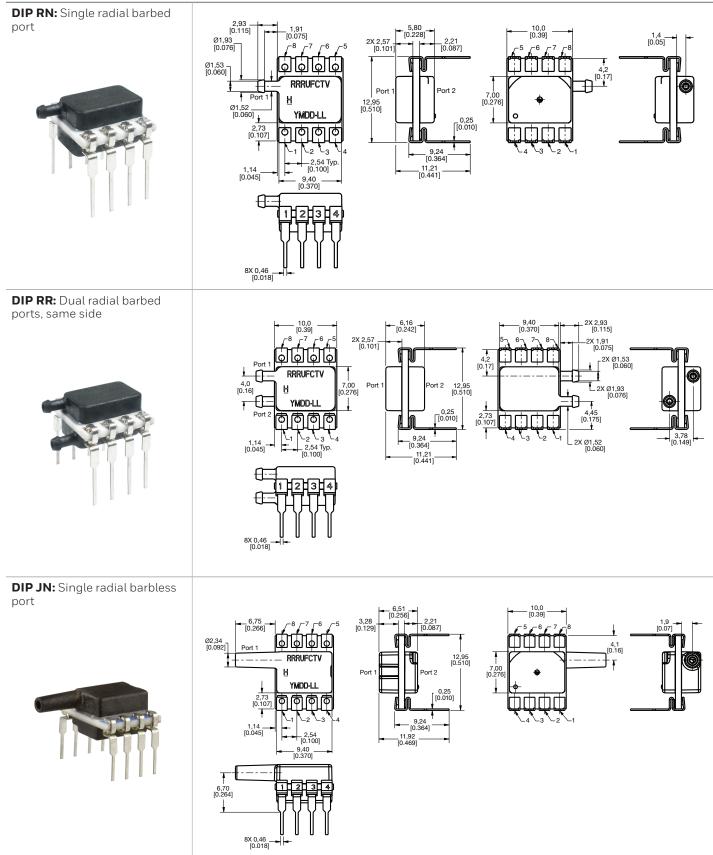
#### DIP NN: No ports



## TruStability<sup>™</sup> Board Mount Pressure Sensors

**RSC** Series

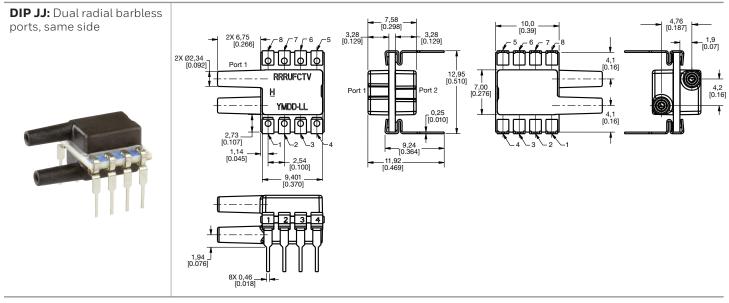
#### Figure 4. DIP Package Dimensional Drawings (continued)



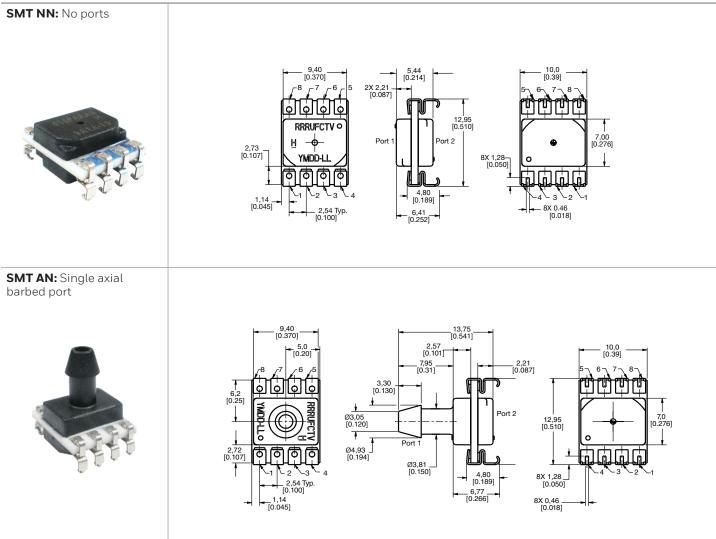
## TruStability<sup>™</sup> Board Mount Pressure Sensors

**RSC** Series

#### Figure 4. DIP Package Dimensional Drawings (continued)



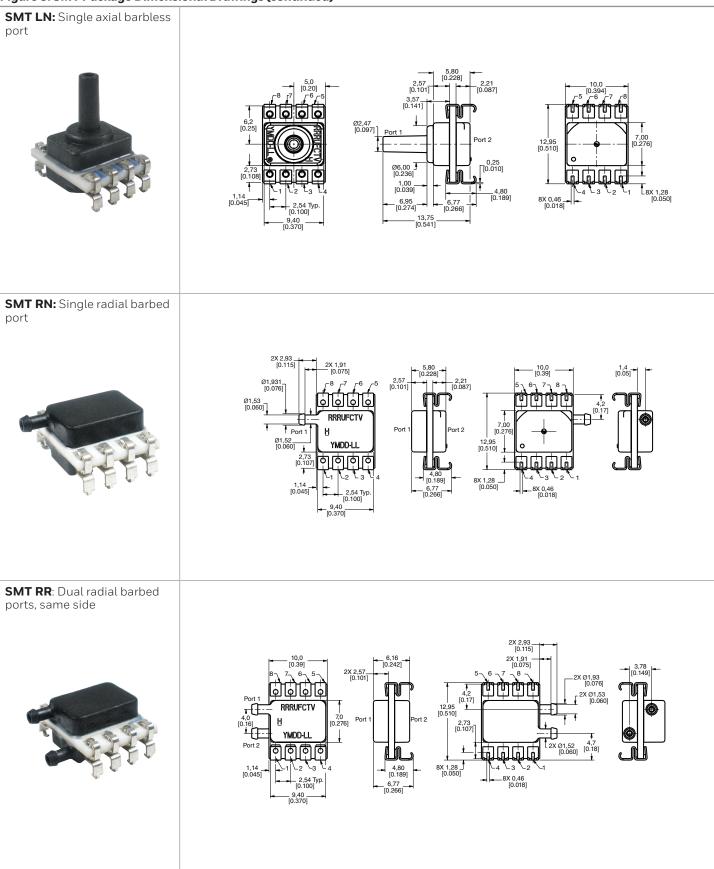
#### Figure 5. SMT Package Dimensional Drawings (For reference only: mm [in].)



12 sensing.honeywell.com

**RSC** Series

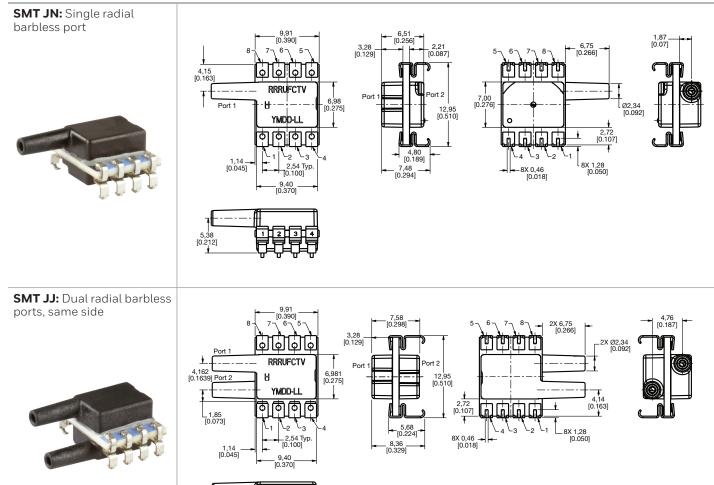
#### Figure 5. SMT Package Dimensional Drawings (continued)



## TruStability<sup>™</sup> Board Mount Pressure Sensors

**RSC** Series

#### Figure 5. SMT Package Dimensional Drawings (continued)



#### Figure 6. Recommended PCB Pad Layouts

1,50

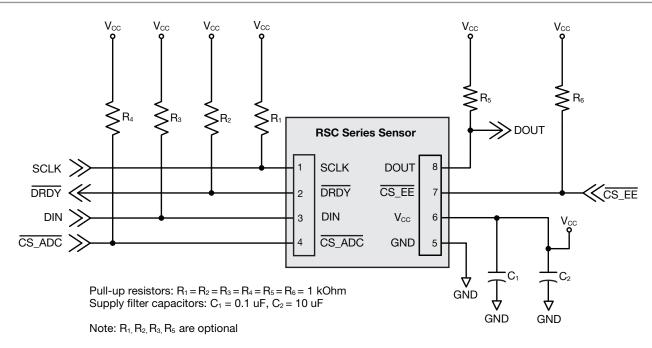


# TruStability<sup>™</sup> Board Mount Pressure Sensors RSC Series

#### Table 9. Pinout

Name	Description
SCLK	external clock source
DRDY	data ready: active low
DIN	serial data input
CS_ADC	ADC chip select: active low
GND	ground
V <sub>CC</sub>	positive supply voltage
CS_EE	EEPROM chip select: active low
DOUT	serial data output
	SCLK DRDY DIN CS_ADC GND V <sub>cc</sub> CS_EE

#### **Figure 7. Recommended Circuit**

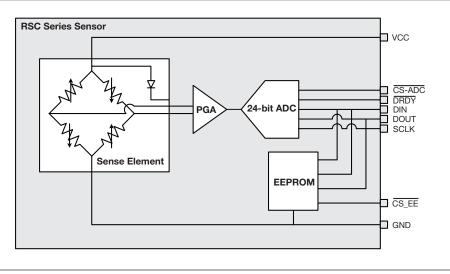


### 1.0 SYSTEM OVERVIEW

#### 1.1 Major System Blocks (see Figure 1-1)

- A piezoresistive Sense Element that provides a signal that changes when pressure is applied to the device.
- An Analog to Digital Converter (ADC) with an integrated amplifier that measures this signal. (Unlike many conventional sensors, this digital signal is neither compensated nor calibrated.)
- An onboard EEPROM Memory that contains the coefficients for compensating equations that can be used to correct the raw signal and provide a fully temperature-compensated, pressure-calibrated value.

#### Figure 1-1. Block Diagram



#### 1.2 High-level Operating Sequence

The following operating sequence is required to make the device function. Each step is discussed in detail in the following sections.

- 1. Read the ADC settings and the compensation values from EEPROM.
- 2. Initialize the ADC converter using the settings provided in EEPROM.
- 3. Adjust the ADC sample rate if desired.
- 4. Command the ADC to take a temperature reading, and store this reading.
- 5. Give Delay (Example: if sample rate is 330SPS delay for 3.03 ms [1/330 s]).
- 6. Command the ADC to take a pressure reading, and store this reading.
- 7. Apply the compensation formulae to the temperature and pressure readings in order to calculate a pressure value.
- 8. Repeat steps 4, 5 and 6 in a loop to take additional readings.

It is not necessary to take a new temperature reading in conjunction with every pressure reading. If a fast response to pressure is required, it is possible to take several pressure readings in a row and use an earlier temperature reading to compensate. The exact timing of this will be application specific and depend on the rapidity of possible temperature changes. A temperature reading approximately every 100 ms should be adequate for most applications except those with rapid temperature transients. Longer times between temperature readings may be possible for applications where rapid temperature changes are not possible. If multiple pressure readings for a single temperature reading are desired, the sequence of steps above becomes:

- 4. Command the ADC to take a temperature reading, and store this reading.
- 5. Command the ADC to take a pressure reading, and store this reading.
- 6. Apply the compensation formulae to the temperature and pressure readings in order to calculate a pressure value.
- 7. Repeat steps 5 and 6 in a loop to take additional pressure readings and compensate them.
- 8. After a pre-determined number of loops, repeat step 4.

#### 1.3 Compensation Mathematics (see Table 1-1)

This section gives a high-level overview of the compensation mathematics. Please refer to Section 2.0 for details on exact numeric formats and EEPROM addresses. It is assumed that all values have been correctly converted to a floating-point decimal format.

Coefficient	Description
P <sub>Range</sub>	pressure range read from EEPROM
P <sub>min</sub>	pressure offset read from EEPROM
Eng Units	engineering units read from EEPROM
P <sub>raw</sub>	uncompensated pressure reading from ADC
T <sub>raw</sub>	uncompensated temperature reading from ADC
P <sub>int1</sub>	intermediate value in calculations
P <sub>int2</sub>	intermediate value in calculations
$P_{Comp_{FS}}$	compensated output pressure
P <sub>Comp</sub>	compensated output pressure, in engineering units

#### Table 1-1. Coefficients Read from EEPROM

 $OffsetCoefficient_3...OffsetCoefficient_0 = Correction values from EEPROM$ SpanCoefficient\_3...SpanCoefficient\_0 = Correction values from EEPROM ShapeCoefficient\_3...ShapeCoefficient\_0 = Correction values from EEPROM

$$\begin{split} & \mathsf{P}_{\mathsf{int1}} = \mathsf{P}_{\mathsf{raw}} - (\mathsf{OffsetCoefficient}_3 * \mathsf{T}_{\mathsf{raw}}^3 + \mathsf{OffsetCoefficient}_2 * \mathsf{T}_{\mathsf{raw}}^2 + \mathsf{OffsetCoefficient}_1 * \mathsf{T}_{\mathsf{raw}} + \mathsf{OffsetCoefficient}_0) \\ & \mathsf{P}_{\mathsf{int2}} = \mathsf{P}_{\mathsf{int1}} / (\mathsf{SpanCoefficient}_3 * \mathsf{T}_{\mathsf{raw}}^3 + \mathsf{SpanCoefficient}_2 * \mathsf{T}_{\mathsf{raw}}^2 + \mathsf{SpanCoefficient}_1 * \mathsf{T}_{\mathsf{raw}} + \mathsf{SpanCoefficient}_0) \\ & \mathsf{P}_{\mathsf{Comp\_FS}} = \mathsf{ShapeCoefficient}_3 * \mathsf{P}_{\mathsf{int2}}^3 + \mathsf{ShapeCoefficient}_2 * \mathsf{P}_{\mathsf{int2}}^2 + \mathsf{ShapeCoefficient}_1 * \mathsf{P}_{\mathsf{int2}} + \mathsf{ShapeCoefficient}_0 \\ & \mathsf{P}_{\mathsf{Comp\_FS}} = (\mathsf{P}_{\mathsf{Comp\_FS}} * \mathsf{P}_{\mathsf{Range}}) + \mathsf{P}_{\mathsf{min}} [\mathsf{Engineering Units}] \end{split}$$

# TruStability<sup>™</sup> Board Mount Pressure Sensors RSC Series

#### 2.0 SYSTEM INITIALIZATION - EEPROM

The device on-board memory contains serialization, pressure range, ADC configuration and compensation information.

#### 2.1 **EEPROM Contents**

#### 2.11 Serialization and pressure range information: Stored in bytes 0 to 40 (see Table 2-1).

Relative Address	Item	Detail	Data Type	Byte Order
0			ASCII Char	MSB
1			ASCII Char	
2			ASCII Char	
3			ASCII Char	
4			ASCII Char	
5			ASCII Char	
6	sensor catalog listing		ASCII Char	
7			ASCII Char	
8			ASCII Char	
9			ASCII Char	
10			ASCII Char	
11			ASCII Char	
12			ASCII Char	
13			ASCII Char	
14			ASCII Char	
15			ASCII Char	LSB
16			ASCII Char	MSB
17			ASCII Char	
18		YYYY	ASCII Char	
19			ASCII Char	LSB
20			ASCII Char	MSB
21	serial number	DDD	ASCII Char	
22	(YYYYDDDXXXX)		ASCII Char	LSB
23			ASCII Char	MSB
24			ASCII Char	
25		XXXX	ASCII Char	
26			ASCII Char	LSB
27				LSB
28				
29	pressure range		Float	
30				MSB
31				LSB
32				
33	pressure minimum		Float	
34				MSB
35			ASCII Char	MSB
36			ASCII Char	
37	pressure unit		ASCII Char	
38			ASCII Char	
39			ASCII Char	LSB
40	pressure reference		ASCII Char	

#### Table 2-1. Serialization and Pressure Range Information

#### 2.12 ADC Configuration Settings: Stored in bytes 61, 63, 65 and 67 (See Table 2-2).

#### Table 2-2. ADC Configuration Setttings

<b>Relative Address</b>	Item	Detail	Data Type	Byte Order
60				
61		ADC CONFIG_00	unsigned character	-
62				
63	ADC configuration math	ADC CONFIG_01	unsigned character	-
64	math			
65		ADC CONFIG_02	unsigned character	-
66				
67		ADC CONFIG_03	unsigned character	-

### 2.13 Polynomial coefficients: Stored in bytes 130 to 145 (see Table 2-3).

#### Table 2-3. Polynomial Coefficients

<b>Relative Address</b>	ltem	Detail	Data Type	Byte Order
130				LSB
131		OffeetCeefficient	float	
132		OffsetCoefficient <sub>0</sub>	noat	
133				MSB
134				LSB
135		OffeetCeefficient	float	
136		OffsetCoefficient <sub>1</sub>	lioat	
137	offset matrix			MSB
138	onsetmathx			LSB
139		OffsetCoefficient <sub>2</sub>	float	
140		OnsetCoentcient <sub>2</sub>	nuar	
141				MSB
142				LSB
143		OffsetCoefficient <sub>3</sub>	float	
144		OnselCoefficient <sub>3</sub>	nudt	
145				MSB

#### 2.14 Span coefficients: Stored in bytes 210 to 225 (see Table 2-4).

#### Table 2-4. Span Coefficients

<b>Relative Address</b>	ltem	Detail	Data Type	Byte Order
210				LSB
211		CranCoofficient	fleet	
212		SpanCoefficient <sub>0</sub>	float	
213				MSB
214				LSB
215		SpanCoafficient	float	
216		$SpanCoefficient_1$	noat	
217	anon motrix			MSB
218	span matrix			LSB
219		Span Coofficient	fleet	
220		SpanCoefficient <sub>2</sub>	float	
221				MSB
222	-			LSB
223		SpanCoafficient	float	
224		$SpanCoefficient_3$	nual	
225				MSB

#### 2.15 Shape Coefficients: Stored in bytes 290 to 305 (see Table 2-5).

#### **Table 2-5. Shape Coefficients**

<b>Relative Address</b>	Item	Detail	Data Type	Byte Order
290				LSB
291		ChangCoofficient	floot	
292		ShapeCoefficiento	float	
293				MSB
294				LSB
295		ShanaCaafficiant	float	
296		ShapeCoefficient1	noat	
297	ahana matuiv			MSB
298	shape matrix			LSB
299		ShanaCaafficiant	float	
300		$ShapeCoefficient_2$	nuar	
301				MSB
302				LSB
303		ShanaCoofficient	floot	
304		ShapeCoefficient₃	float	
305				MSB

#### 2.16 Checksum address: Stored in byte 450 (see Table 2-6).

#### Table 2-6. Checksum Address

<b>Relative Address</b>	ltem	Detail	Data Type	Byte Order
450	Charlesum		upping ad about int	LSB
451	Checksum		unsigned short int	MSB

Any unspecified EEPROM addresses below address 451 are reserved for future enhancements.

#### 2.2 EEPROM Communications

The  $\overline{\text{CS}_{\text{EE}}}$  pin of the sensor selects the EEPROM for SPI communication. When  $\overline{\text{CS}_{\text{EE}}}$  is high, the EEPROM is in stand-by mode, and communications with the ADC are possible. When  $\overline{\text{CS}_{\text{EE}}}$  is low, the EEPROM is enabled.  $\overline{\text{CS}_{\text{EE}}}$  and  $\overline{\text{CS}_{\text{ADC}}}$  must never be simultaneously low. EEPROM operates in SPI mode 0 where CPOL = 0 and CPHA = 0 (0,0) and mode 3 where CPOL = 1 and CPHA = 1 (1,1).

Each memory of EEPROM contains 8-bit data or one byte. To read from memory, the host sends an EAD\_EEPROM instruction [0000 X011] followed by an 8-bit address. The 'X' bit in the read instruction is the ninth (MSB) address bit.

Example:

1. To read data at address 1, the command sequence is  $[0000 \ 0011] \ [0000 \ 0001].$ 

2. To read data at address 290, the command sequence is  $[0000 \ 1011] \ [0010 \ 0010]$ .

After receiving the last address bit, the EEPROM responds by shifting out data on the DOUT pin, as shown in Figure 2-1. Sequentially stored data can be read out by simply continuing to run the clock. The internal address pointer is automatically incremented to the next higher address as data is shifted out. After reaching the highest memory address, the address counter "rolls over" to the lowest memory address, and the read cycle can be continued indefinitely. The read operation is terminated by taking CS\_EE high.

#### Figure 2-1. EEPROM Communications

CS_EE		
SCLK		2
DIN	Op Code     Byte Address       X     0     0     0     X*     0     1     1     A <sub>7</sub> A <sub>6</sub> XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	*****
DOUT	High Impedance D7 D6 D5 D4 D3 D2 MSB	D1 D0

#### 3.0 SYSTEM OPERATION – ADC

#### 3.1 ADC Communications and Initialization

The  $\overline{\text{CS}_\text{ADC}}$  pin of the sensor selects the ADC for SPI communication. When  $\overline{\text{CS}_\text{ADC}}$  is high, the ADC is in stand-by mode, and communications with the EEPROM are possible. When  $\overline{\text{CS}_\text{ADC}}$  is low, the ADC is enabled.  $\overline{\text{CS}_\text{EE}}$  and  $\overline{\text{CS}_\text{ADC}}$  must never be simultaneously low. The ADC interface operates in SPI mode 1 where CPOL = 0 and CPHA = 1.

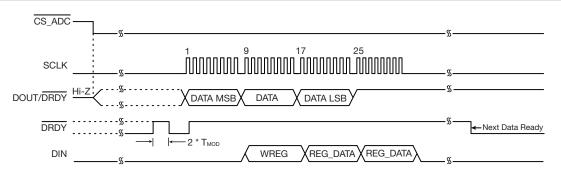
The ADC has four configuration registers. Three registers are 'reserved' and must be set to the default values contained in EEPROM. These registers contain setup values that are specific to the pressure sense element, and should not be changed. Configuration register 1 toggles the ADC between pressure and temperature readings and controls the data rate of the ADC.

To program a configuration register, the host sends a WREG command [0100 RRNN], where 'RR' is the register number and 'NN' is the number of bytes to be written -1.

Example: To write the single byte default configuration to register 3, the command is [0100 1100]. It is possible to write the default values to all configuration registers with a single command by setting the address to 0 and the number of bytes to (4 -1) = 3, followed by all four configuration bytes in sequence. The command for this is [0100 0011].

The ADC is capable of full-duplex operation, which means commands are decoded at the same time that conversion data are read. Commands may be sent on any 8-bit data boundary during a data read operation. This allows for faster toggling between pressure and temperature modes. A WREG command can be sent without corrupting an ongoing read operation. Figure 3-1 shows an example of sending a WREG command while reading conversion data. Note that after the command is clocked in (after the 32nd SCLK falling edge), the sensor changes settings and starts converting using the new register settings. The WREG command can be sent on any of the 8-bit boundaries – the first, ninth, 17th or 25th SCLK rising edges as shown in Figure 3-1.

#### Figure 3-1. ADC Communciations and Initialization



#### 3.2 Programming the Data Rate and Pressure/Temperature Modes

The ADC configuration register 1 contains the settings for the data rate and determines whether the ADCS takes a pressure reading or a temperature reading. This register can be changed as shown in Table 3-1 by using a WREG command. Typical data conversion times are shown in Table 3-2.

#### Table 3-1. ADC Configuration Register

ADC_CONFIG_01 [HEX]	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit O
01h		DR[2:0]		MOD	E[1:0]	1	TS	0
	Data Ra	ite		Operating Mod	e	set to 1	Temperature Sensor Mode	set to O
		5 0 0 00		00: <b>Normal Mo</b> modulator cloc 01: not used 10: <b>Fast Mode</b> modulator cloc	k) (default) (512 kHz		O: Pressure (sense element) reading 1: Temperature reading	
		0 0 00 00 00						

#### Table 3-2. Typical Data Conversion Times

	Normal Mode		Fast Mode
SPS	Time (ms)	SPS	Time (ms)
20	49.99	40	25.00
45	22.25	90	11.12
90	11.26	180	5.63
175	5.78	350	2.89
330	3.04	660	1.52
600	1.68	1200	0.84
1000	1.01	2000	0.51

**RSC** Series

### 3.3 ADC Reset Command

The ADC reset command RESET [0000 0110] resets the ADC to the default values.

#### 3.4 ADC Programming Sequence – Power Up

At power-up it is necessary to initialize all the ADC registers. The sequence is:

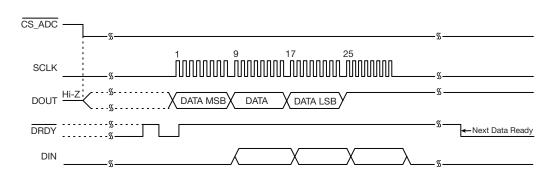
- 1. Set the  $\overline{\text{CS}_{\text{EE}}}$  to high to disable EEPROM communication.
- 2. Set the  $\overline{\text{CS}}_{\text{ADC}}$  to low to enable ADC communication.
- 3. Initialize all four configuration registers to the default values in the EEPROM's Relative addresses 61, 63, 65 and 67 (see the MSB bytes in see Section 3.0) by sending a WREG command to address 0 [0100 0011] followed by the four bytes of data:
  - Send the the Reset command (06h) to make sure the ADC is properly reset after powerup
  - Write the respective register configuration using the WREG command (Example: 43h, 0Ah, 84h, 40h, and 00h)

Both a temperature and an uncompensated pressure reading are necessary to calculate a compensated value (see Section 3.5).

#### 3.5 ADC Programming and Read Sequence – Temperature Reading (see Figure 3-2 and Table 3-3)

- 1. Set the  $\overline{\text{CS}}_{\text{ADC}}$  low to enable ADC communication.
- Configure the sensor to temperature mode and the desired data rate by setting configuration register 1 by sending a WREG command to address 1, [0100 0100] followed by the single configuration byte. Bit 1 (TS) of the configuration register should be set to 1.
- 3. Send 08h command to start data conversion on ADC.
- 4. The sensor will start to output the requested data on DOUT at the first SCLK rising edge after the command byte is received.

#### Figure 3-2. ADC Programming and Read Sequence – Temperature Reading



5. Interpret the data as follows: Temperature data are output starting with MSB. When reading 24 bits, the first 14 bits are used to indicate the temperature measurement result. The last 10 bits are random data and must be ignored. Negative temperature is represented in 2's complement format. MSB = 0 indicates positive result, MSB = 1 indicates negative value.

To convert the digital value to a Celsius temperature, first check if the MSB is 0 or 1. If the MSB = 0, simply multiply the decimal code by  $0.03125^{\circ}$ C to obtain the result. If the MSB = 1, subtract 1 from the result and complement all bits, multiply the result by  $-0.03125^{\circ}$ C.

#### Table 3-3. Data Interpretation Table

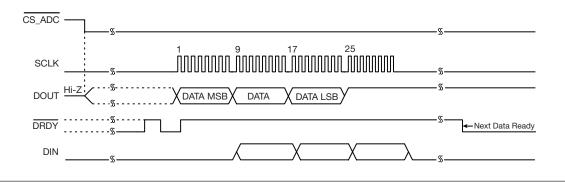
Temperature (°C)	Digital Output (Binary)	Hex
128	01 0000 0000 0000	1000
127.96875	00 1111 1111 1111	OFFF
100	0011001000000	0C80
80	00 1010 0000 0000	0A00
75	00 1001 0110 0000	0960
50	00 01 10 01 00 00 00 00 00 00 00 00 00 0	0640
25	00 0011 0010 0000	0320
0.25	00 0000 0000 1000	0008
0	00 0000 0000 0000	0000
-0.25	11 1111 1111 1000	3FF8
-25	11 1100 1110 0000	3CE0
-40	11 1011 0000 0000	3B00

**Example 1:** The ADC reads back 0960h: 0960h has an MSB = 0. (0960h) × (0.03125°C) = (2400) × (0.03125°C) = 75°C **Example 2:** The ADC reads back: 3CE0h: 3CE0h has an MSB = 1. Complement the result: 3CE0h = 0320h (0320h) × (-0.03125°C) = (800) × (-0.03125°C) = -25°C

#### 3.6 ADC Programming and Read Sequence – Pressure Reading (see Figure 3-3)

- 1. Set the  $\overline{\text{CS}}_{\text{ADC}}$  low to enable ADC communication.
- 2. Configure the sensor to the pressure mode and the desired data rate by setting configuration register 1 by sending a WREG command to address 1, [0100 0100] followed by the single configuration byte. Bit 1 (TS) of the configuration register should be set to 0.
- 3. Send 08h command to start data conversion on ADC.
- 4. The sensor will start to output the requested data on DOUT at the first SCLK rising edge after the command byte is received.

#### Figure 3-3. ADC Programming and Read Sequence – Pressure Reading



5. Interpret the data as shown in Table 3-4. Pressure data are output starting with MSB, in 24-bit 2's complement format.

able 5-4. Compretum_Struct				
Input Signal, VIN (AINP-AINN)	DEAL OUTPUTCODE			
≥+FS(2 <sup>23</sup> -1)/2 <sup>23</sup>	7FFFFh			
+FS / 2 <sup>23</sup>	000001h			
0	0			
-FS / 2 <sup>23</sup>	FFFFh			
≤ -FS	800000h			

#### Table 3-4. CompReturn\_Struct

#### 4.0 EXAMPLE SOFTWARE

#### 4.1 Data Types

Specific data types defined by the Pressure\_Comp module defined in "Pressure\_Comp.h" are needed while interacting with the pressure compensation function (see Table 4-1).

#### Table 4-1. Data Types

Name	Description				
	Provides an enumerated data type to hold the status of pressure compensation module; pressure				
	compensation states are given be	elow:			
	COMPINIT_OK	Compensation init successful			
	COMPINIT_NOK	Compensation init failure			
CompStatus_Enum	CRC_FAILURE	CRC check failure			
	IP_PRESSURE_OUTOFRANGE	Input pressure out of range			
	IP_TEMP_OUTOFRANGE	Input temperature out of range			
	PRESSURE_VALID	Output pressure is valid			
	PRESSURE_INVALID	Output pressure is invalid			
	Provides structured a data type containing two elements such as f32PressureOutput and				
	CompStatus; details are given below:				
CompReturn_Struct		Provides output pressure of "float" data type			
	f32PressureOutput	Provides status of pressure compensation of "CompStatus_Enum"			
	CompStatus	data type			

#### 4.2 Function Descriptions – Pressure\_Comp.c

"Pressure\_Comp.c" provides the source code that provides functions to initialize the module by extracting all the coefficients from EEPROM after CRC validation and extracting the coefficients from it. This file also provides the function to compensate the pressure by having uncompensated raw pressure and temperature input. The "Pressure\_Comp.h" file provides the interfaces to the functions implemented in the "Pressure\_Comp.c" file that need to be included in the application where the pressure compensation is needed. Dependencies: "float.h", "crc.h" (see Tables 4-2, 4-3 and 4-4).

#### Table 4-2. Compensate\_Pressure\_Init()

Entity	Name	Description
Function	Compensate_Pressure_Init	Initializes the pressure compensation module
		Data Type: (unsigned char *)
Parameter	u8EEPROM_ptr	Provides a pointer to the EEPROM image which is read byte-wise in
		a contiguous memory buffer
		Returns the status of compensation initialization (either of the
	CompStatus_Enum	compensation states given below)
Return Type		COMPINIT_OK Compensation init successful
		COMPINIT_NOK Compensation init failure

#### Table 4-3. Compensate\_Pressure()

Entity	Name	Description
Function	Compensate_Pressure	Provides the compensated pressure based on the polynomial correction
Deverseter	u32PressureInput	Data Type: (unsigned long int) Inputs the uncompensated pressure as read by the sensor
Parameter u32Temperature	u32Temperature	Data Type: (unsigned long int) Inputs the temperature as read by the sensor
	CompReturn_Struct. CompStatus	Data Type: (CompStatus_Enum) Provides the status of the compensation initialization
Return type CompReturn_Struct. f32PressureOutput		Data Type: (float) Returns the compensated pressure output in engineering units per the sensor's specification

#### Table 4-4. AutoZero\_Pressure()

Entity	Name	Description
Function	Autozero_Pressure	Sets a known, preset pressure to 50% full scale pressure (this function
		should only be used at a known preset pressure that has to be output as
		50% full scale pressure)
		The term "autozero" refers to 50% full scale pressure
Parameter	u32PressureZero	Data Type: (unsigned long int)
		Inputs uncompensated pressure as read by the TSHUR sensor at preset
		50% full scale pressure
	u32TemperatureZero	Data Type: (unsigned long int)
		Inputs temperature as read by the TSHUR sensor at preset 50% full scale
		pressure
Return type	CompReturn_Struct.	Data Type: (CompStatus_Enum)
	CompStatus	Returns the status of AutoZero Correction

#### 4.3 Checksum Calculation

"crc.c" provides a source code which, in turn, provides the functions to compute the 16-bit CCITT CRC. "crc.h" is an interface file for "pressure\_Comp.c" to get the interfaces to the functions which are implemented in the "crc.c" file (see Table 4-5).

#### Table 4-5. CrcComputeCrc16()

Entity	Name	Description	
Function	CrcComputeCrc16	Computes the 16-bit CRC-16-CCITT checksum	
		Uses a lookup table to compute the CRC-16-CCITT checksum with the	
		generator polynomial = 0x1021	
Parameter	u8Data	Data Type: (unsigned char)	
		Provides the current data passed to compute the CRC	
	u16CurrCrc	Data Type: (unsigned short int)	
		Provides the previously computed CRC Checksum	
Return type	unsigned short int	Returns the updated CCITT 16 bit CRC	

#### 4.4 Compensation Sequence

- 1. Set the endianness of the processor/controller where the sample code is planned to be integrated in "Pressure\_Comp.h" file Defines section (set only one of the following):
  - If little-endian, set "#define LITTLE\_ENDIAN\_FORMAT"
  - If big-endian, set "#define BIG\_ENDIAN\_FORMAT"
- 2. Include the four source files "Pressure\_Comp.c", "Pressure\_Comp.h", "crc.c", "crc.h" into the project build directory structure.
- 3. Include the interface "#include "Pressure\_Comp.h" in the source file where the pressure needs to be compensated.
- 4. Read and store the EEPROM contents in the application memory.
- 5. Initialize the "Pressure\_Comp" module by calling the Compensate\_Pressure\_Init() function by passing the buffer pointer to the function. Check for the return status of type "CompStatus\_Enum" ensure the same is "COMPINIT\_OK".
- 6 Set the reference pressure and temperature at which the AutoZero correction should happen. Read the raw pressure and temperature data from the sensor, pass the same as parameters to the AutoZero\_Pressure() function. Check for the return status of type "CompStatus\_Enum" to ensure it is the same as "COMPINIT\_OK".
- 7. Read the raw pressure and temperature data from the sensor, pass the same as parameters to the Compensate\_Pressure() function. Check "CompReturn\_Struct.CompStatus" returned is PRESSURE\_VALID and get the compensated pressure data from "CompReturn\_Struct.f32PressureOutput".

### NOTICE

Initialization of the "Pressure\_Comp" module is done by calling the Compensate\_Pressure\_Init() function prior to calling the Compensate\_Pressure() function. If the initialization is not successful the same status is outputted from the Compensate\_ Pressure() function. When the Compensate\_Pressure() function returns any status other than the PRESSURE\_VALID status, the output pressure data should be discarded and should not be processed further.

#### 4.5 Constraints

The following considerations must be met to ensure the compiler settings are set to achieve the data type sizes shown in Table 4-6.

- Ensure the "float" data type is as per the IEEE 754 single-precision binary floating-point format: binary32.
- Ensure the endianness of the microcontroller has been configured correctly in the "Pressure\_Comp.h" function.
- Ensure the sample code has a minimum of 1 kB of RAM for its operation.

#### Table 4-6. Data Type Sizes

Data Type	Size
Unsigned char 1	1 byte
Float	4 byte (IEEE754)
Unsigned short int	2 byte
Unsigned long int	4 byte

### NOTICE

The sample code provided has been tested on a limited number of microcontrollers and compliers to ensure proper functionality on a well defined/designed target system. The application developer needs to ensure compiler dependence as well as compatibility of the code with target environment.

### 5.0 SENSOR OFFSET ZERO CORRECTION PROCEDURE

Offset correction is a compensation technique based on sampling the output at a known reference condition within the compensated temperature and compensated pressure range of the sensor. Typically, a zero pressure reference, such as atmospheric pressure (or equal pressures on both pressure ports for a differential device), is used to allow the external correction of the offset error. Use the following sequence:

- 1. Set the sensor to zero pressure.
- 2. Measure  $\mathsf{P}_{\mathsf{raw}}$  and  $\mathsf{T}_{\mathsf{raw}}$  at a known zero reference ( $\mathsf{P}_{\mathsf{raw0}},\mathsf{T}_{\mathsf{raw0}},\mathsf{for}\ \mathsf{example}$ ).
- 3. Calculate  $P_{raw\_AZero} = (OffsetCoefficient_3 * T_{raw0}^3 + OffsetCoefficient_2 * T_{raw0}^2 + OffsetCoefficient_1 * T_{raw0} + OffsetCoefficient_0) P_{raw0}$ .
- 4. Add the  $P_{raw\_AZero}$  value to all  $P_{raw}$  values for use in the standard algorithm (see Section 1.3).
- 5. Calculate  $\mathsf{P}_{\mathsf{int1}}$  and  $\mathsf{P}_{\mathsf{int2}}$  as usual but use the modified  $\mathsf{P}_{\mathsf{raw}}$  values.

#### **ADDITIONAL INFORMATION**

The following associated literature is available on the Honeywell web site at sensing.honeywell.com:

The following associated literature is available at sensing. honeywell.com:

- Product line guide
- Product range guide
- Installation instructions
- Application information
- Sensor Evaluation Kit (SEK001) information including user instructions and software downloads

### Find out more

Honeywell serves its customers through a worldwide network of sales offices and distributors. For application assistance, current specifications, pricing or name of the nearest Authorized Distributor, contact your local sales office.

To learn more about Honeywell's sensing and switching products, call +1.815.235.6847 or 1.800.537.6945, visit sensing.honeywell.com, or e-mail inquiries to info.sc@honeywell.com

### A WARNING PERSONAL INJURY

DO NOT USE these products as safety or emergency stop devices or in any other application where failure of the product could result in personal injury.

Failure to comply with these instructions could result in death or serious injury.

### A WARNING MISUSE OF DOCUMENTATION

- The information presented in this datasheet is for reference only. Do not use this document as a product installation guide.
- Complete installation, operation, and maintenance information is provided in the instructions supplied with each product.

Failure to comply with these instructions could result in death or serious injury.

#### Warranty/Remedy

Honeywell warrants goods of its manufacture as being free of defective materials and faulty workmanship during the applicable warranty period. Honeywell's standard product warranty applies unless agreed to otherwise by Honeywell in writing; please refer to your order acknowledgement or consult your local sales office for specific warranty details. If warranted goods are returned to Honeywell during the period of coverage, Honeywell will repair or replace, at its option, without charge those items that Honeywell, in its sole discretion, finds defective. **The foregoing is buyer's sole remedy and is in lieu of all other warranties, expressed or implied, including those of merchantability and fitness for a particular purpose. In no event shall Honeywell be liable for consequential, special, or indirect damages.** 

While Honeywell may provide application assistance personally, through our literature and the Honeywell web site, it is buyer's sole responsibility to determine the suitability of the product in the application.

Specifications may change without notice. The information we supply is believed to be accurate and reliable as of this writing. However, Honeywell assumes no responsibility for its use.

#### Honeywell Sensing and Internet of Things

9680 Old Bailes Road Fort Mill, SC 29707 www.honeywell.com

32321348-C-EN | C | 11/17 © 2017 Honeywell International Inc. 单击下面可查看定价,库存,交付和生命周期等信息

>>Honeywe11(霍尼韦尔)